

SUPPORTING INFORMATION

Dielectric dispersion and superior thermal characteristics in isotope-enriched hexagonal boron nitride thin films: evaluation as thermally self-dissipating dielectrics for GaN transistor

Soon Siang Chng¹, Minmin Zhu^{2,*}, Zehui Du², Xizu Wang³, Matthew Whiteside¹, Zhi Kai Ng¹, Maziar Shakerzadeh¹, Siu Hon Tsang², and Edwin Hang Tong Teo^{1,*}

¹ *School of Electrical and Electronic Engineering, Nanyang Technological University, 50 Nanyang Avenue, Singapore 639798*

² *Temasek Laboratories, Research Techno Plaza, 50 Nanyang Drive, Singapore 637553*

³ *Institute of Materials Research and Engineering (IMRE), Agency for Science, Technology and Research (A*STAR), 2 Fusionopolis Way, Singapore 138634*

Email: mmzhu@ntu.edu.sg or htteo@ntu.edu.sg

Table S1 Table of Deposition Parameters for all the samples

Sample Name	Power Density of B ¹⁰ Target / W cm ⁻²	Power Density of B ¹¹ Target / W cm ⁻²	Process Current to B ¹⁰ Target / mA	Process Current to B ¹¹ Target / mA	Peak Current of B ¹⁰ Target / A	Peak Current of B ¹¹ Target / A	Discharge Voltage of B ¹⁰ Target / V	Discharge Voltage of B ¹¹ Target / V
Pure B ¹⁰	79.77	N/A	450	N/A	9	N/A	645	N/A
Pure B ¹¹	N/A	65.79	N/A	400	N/A	9	N/A	600
50% B ¹⁰ 50% B ¹¹	76.48	76.48	363	450	5	5	764	647
60% B ¹⁰ 40% B ¹¹	82.24	54.82	400	330	5	4	751	611
80% B ¹⁰ 20% B ¹¹	109.65	27.96	524	170	11	2	775	607
Sample Name	Power Density of B Target / W cm ⁻²		Process Current to B Target / mA	Peak Current of B Target / A	Discharge Voltage of B Target / V			
19.1% B ¹⁰ 80.1% B ¹¹ <i>Target is Pure Boron Target of Natural Abundance</i>	73.58		421	7	784			

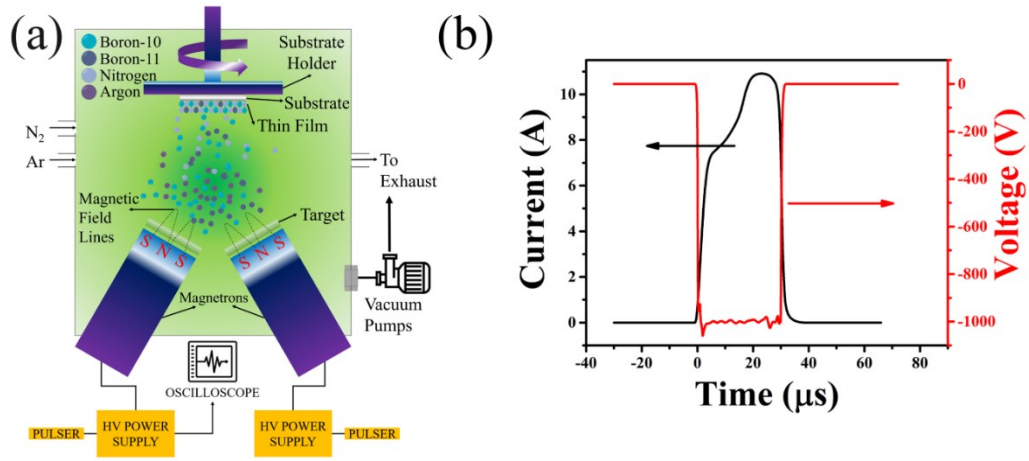


FIG. S1 (a) A schematic of the dual-sputtering HIPIMS system, with the vacuum pumps shown. (b) A schematic of a typical HIPIMS pulse supplied by the power source. The peak current as shown is around 10A and the voltage supplied to the target is around -1000V.

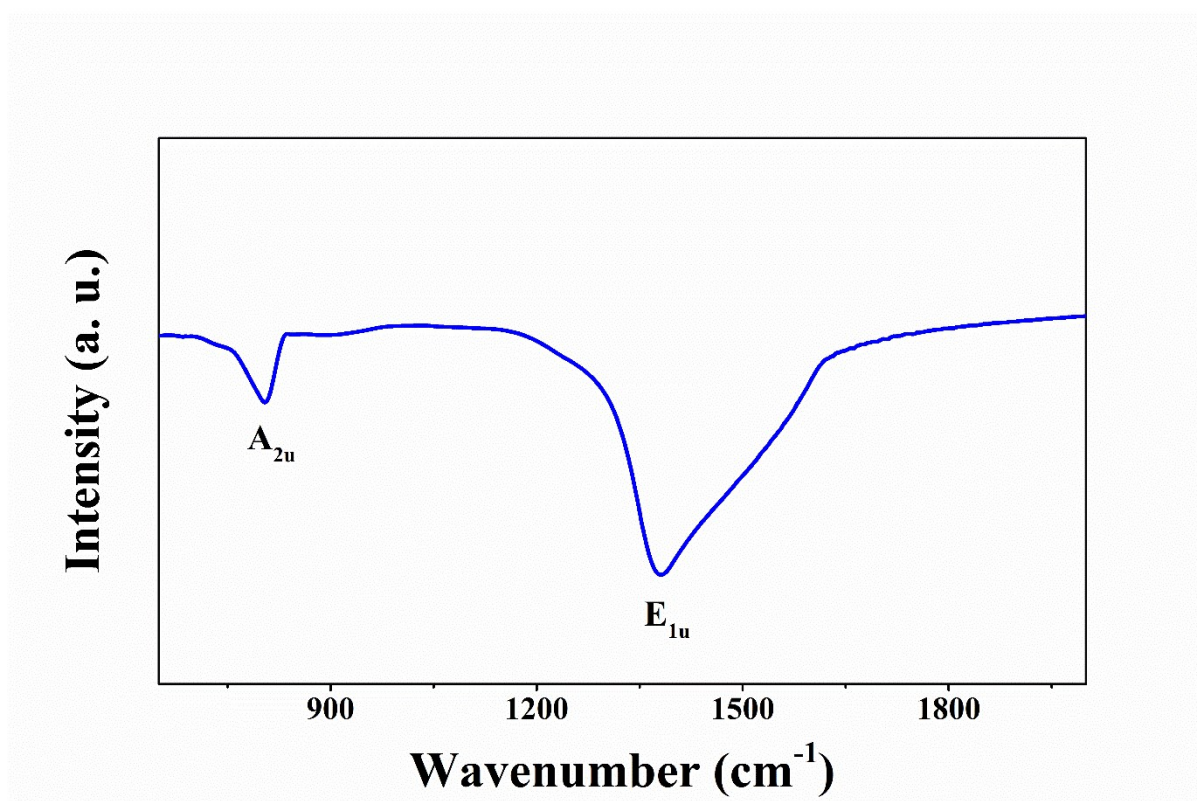
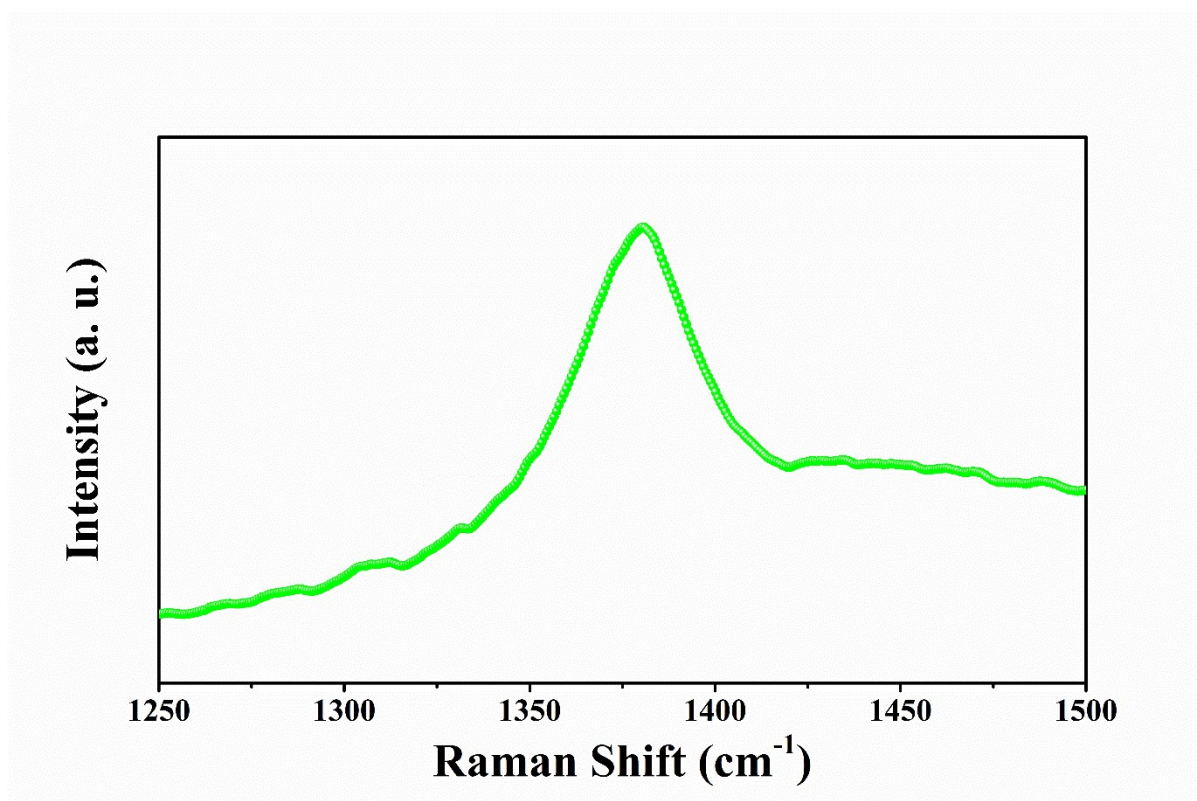


FIG. S2 (a) Raman and (b) FTIR spectra of h-B^{NATN} thin films.

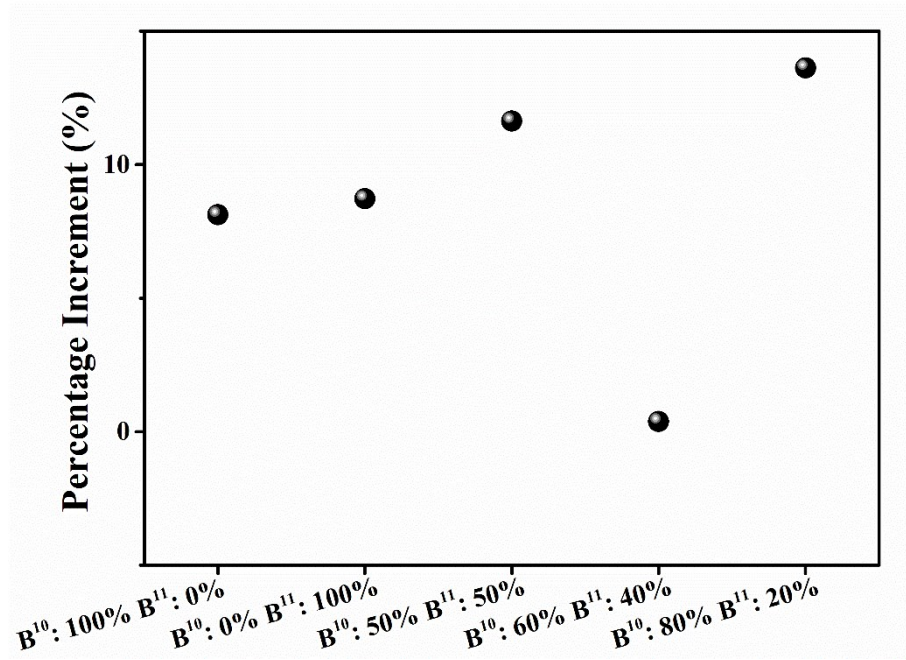


FIG. S3 Percentage increment in thermal conductivities for the h-BN samples with different isotopic compositions at 300 °C as compared to room temperature.

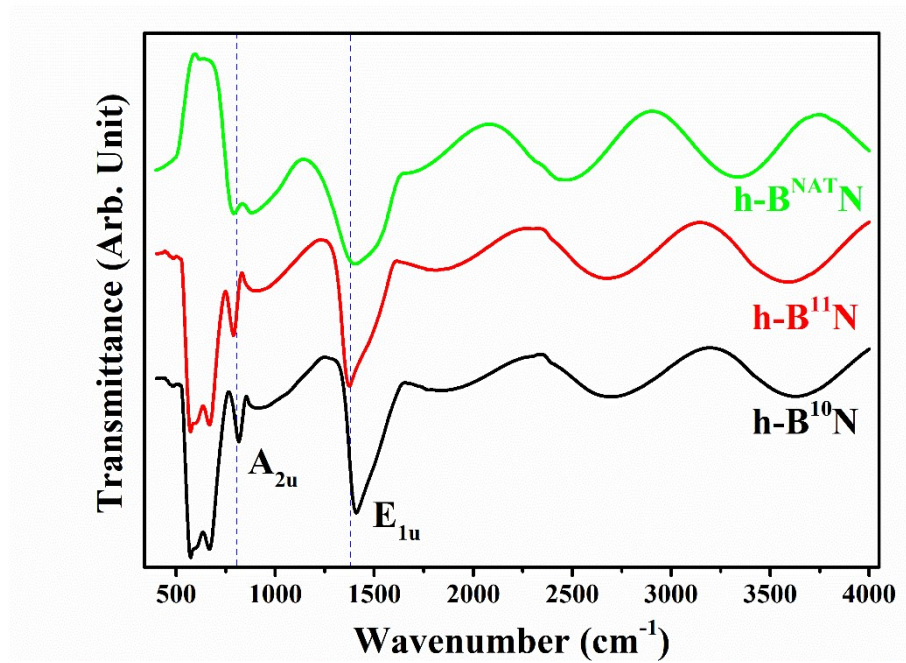


FIG. S4 FTIR spectra of h-B¹⁰N, h-B¹¹N and h-B¹⁰N¹¹ on GaN substrate.

Table S2 Post-deposition percentage change in electronic properties of h-BN thin films deposited on GaN substrates

Sample Label	Post-Deposition Percentage Change in Sheet Concentration / %	Post-Deposition Percentage Change in Hall Mobility / %	Post-Deposition Percentage Change in Sheet Concentration / %
h-B ¹⁰ N	-60.662	24.6732	17.34394
h-B ¹¹ N	-68.5439	56.3964	-36.3717
h-B ^{NAT} N	-14.6301	50.6982	-79.626